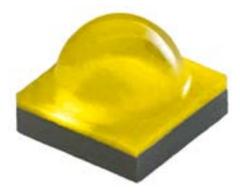


## Cree<sup>®</sup> XLamp<sup>®</sup> XB-D LEDs





The XLamp XB-D LED brings next generation performance and price to LED lighting applications. The XLamp XB-D delivers similar performance to XLamp XP LEDs in a package that is 48% smaller than the XP footprint.

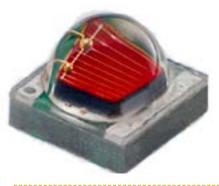
Using Cree's newest generation of silicon carbide-based LED chips, XB-D is optimized to dramatically lower system cost in any illumination application.



#### **FEATURES**

- Cree's smallest lighting class LED: 2.45 X 2.45 mm
- XB-D white binned @ 85 °C: XB-D color binned @ 25 °C
- Up to 136 lm/W in cool white (@ 85 °C, 350 mA)
- Available in white, 80-minimum CRI white, and 70-minimum CRI cool white, royal blue, blue, green, red-orange & red
- 1 A maximum drive current
- Wide viewing angle: from 115° (white) to 140° (red)
- Reflow solderable JEDEC J-STD-020C compatible
- Unlimited floor life at ≤ 30 °C/85% RH
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- **UL-recognized** component (E349212)





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#### FLUX CHARACTERISTICS (T, = 85 °C) - WHITE

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D Binning and Labeling document.

Color	CCT Range		Base Order Codes Min. Luminous Flux @ 350 mA			Calculated Minimum Luminous Flux (lm)**		Order Code	
	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1000 mA		
			R2	114	130	196	253	XBDAWT-00-0000-000000E51	
Cool White	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-000000F51	
			R4	130	148	224	289	XBDAWT-00-0000-000000G51	
			R2	114	130	196	253	XBDAWT-00-0000-00000BE51	
70 CRI Minimum Cool White	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-00000BF51	
			R4	130	148	229	289	XBDAWT-00-0000-00000BG51	
		5000 K	Q4	100	114	172	222	XBDAWT-00-0000-00000LCE4	
Neutral White	3700 K		Q5	107	122	184	237	XBDAWT-00-0000-00000LDE4	
			R2	114	130	196	253	XBDAWT-00-0000-00000LEE4	
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000HAE7	
80 CRI Minimum White	2600 K	6200 K	Q3	93.9	107	162	208	XBDAWT-00-0000-00000HBE7	
			Q4	100	114	172	222	XBDAWT-00-0000-00000HCE7	
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000LAE7	
Warm White	2600 K	3700 K	Q3	93.9	107	162	208	XBDAWT-00-0000-00000LBE7	
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE7	

#### Notes:

- Cree maintains a tolerance of  $\pm 7\%$  on flux and power measurements,  $\pm 0.005$  on chromaticity (CCx, CCy) measurements and  $\pm 2$  on CRI measurements.
- Typical CRI for Neutral White, 3700 K 5000K CCT is 75.
- Typical CRI for Warm White, 2600 K 3700 K CCT is 80.
- Minimum CRI for 70 CRI Minimum Cool White is 70.
- Minimum CRI for 80 CRI Minimum White is 80.
- \* Flux values @ 25 °C are calculated and are for reference only.
- \*\* Calculated flux values at 700 mA and 1000 mA are for 85 °C and are for reference only.



### FLUX CHARACTERISTICS ( $T_1 = 25$ °C) - COLOR

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D Binning and Labeling document.

	Dominant Wavelength Range			rder Codes adiant Flux				
Color	Mi	n.	Ma	Max.		@ 350 mA	Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)		
					30 (J)	450	XBDROY-00-0000-000000J01	
	Royal D36 450 D5		465	31 (K)	475	XBDROY-00-0000-000000K01		
Royal		D57		32 (L)	500	XBDROY-00-0000-000000L01		
Blue		D57		33 (M)	525	XBDROY-00-0000-000000M01		
					34 (N)	550	XBDROY-00-0000-000000N01	
					35 (P)	575	XBDROY-00-0000-000000P01	

	Dominant Wavelength Range					rder Codes		
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)			
		B3 465 B6		485	J0	23.5	XBDBLU-00-0000-000000X01	
Blue	D.S.		D.C		K2	30.6	XBDBLU-00-0000-000000Y01	
blue	blue b3 403		ВО		К3	35.2	XBDBLU-00-0000-000000Z01	
					M2	39.8	XBDBLU-00-0000-000000201	

	Dominant Wavelength Range				rder Codes minous Flux								
Color	Mi				@ 350 mA	Order Code							
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)								
				535	P4	80.6	XBDGRN-00-0000-000000901						
Croon	Green G2 520	G4	E2E		E2E	535	E2E	E2E	E2E	E2E	Q2	87.4	XBDGRN-00-0000-000000A01
Green		320	G4		Q3	93.9	XBDGRN-00-0000-000000B01						
					Q4	100	XBDGRN-00-0000-000000C01						



	Dominant Wavelength Range			rder Codes minous Flux							
Color	Mi	in.	Ma	ix.		@ 350 mA	Order Code				
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)						
									P2	67.2	XBDRDO-00-0000-000000701
				620	Р3	73.9	XBDRDO-00-0000-000000801				
Red- Orange	О3	610	04		620	P4	80.6	XBDRDO-00-0000-000000901			
					Q2	87.4	XBDRDO-00-0000-000000A01				
			Q3	93.9	XBDRDO-00-0000-000000B01						

	Dominant Wavelength Range					rder Codes	Order Code	
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA			
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (Im)			
		R2 620 R3	D.2	630	N3	56.8	XBDRED-00-0000-00000501	
Red	D.O.				N4	62.0	XBDRED-00-0000-000000601	
Red	u R2 620		K3		P2	67.2	XBDRED-00-0000-000000701	
				Р3	73.9	XBDRED-00-0000-000000801		

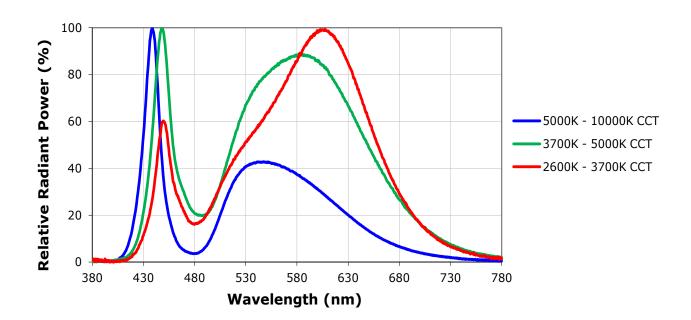
Note: Cree maintains a tolerance of +/-7% on flux and power measurements.

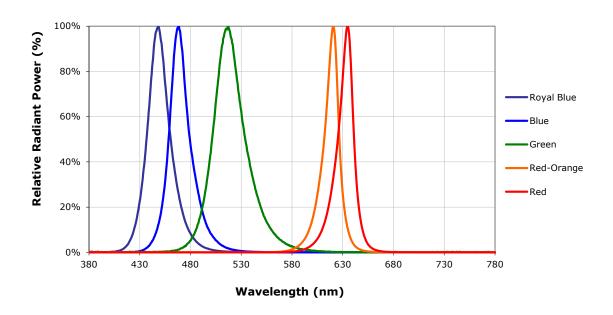
#### **CHARACTERISTICS**

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		6.5	
Thermal resistance, junction to solder point - green	°C/W		11	
Thermal resistance, junction to solder point - red-orange, red	°C/W		5	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - red-orange, red	degrees		140	
Temperature coefficient of voltage - white	mV/°C		-2.5	
Temperature coefficient of voltage - royal blue, blue, green	mV/°C		-3.3	
Temperature coefficient of voltage - red-orange, red	mV/°C		-2	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			1000
Reverse voltage	V			-5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.5
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.7
Forward voltage (@ 350 mA, 25 °C) - green	V		3.3	3.9
Forward voltage (@ 350 mA, 25 °C) - red-orange, red	V		2.25	2.6
LED junction temperature	°C			150



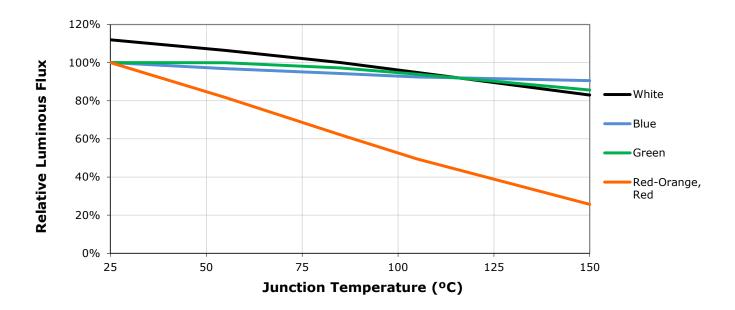
#### **RELATIVE SPECTRAL POWER DISTRIBUTION**

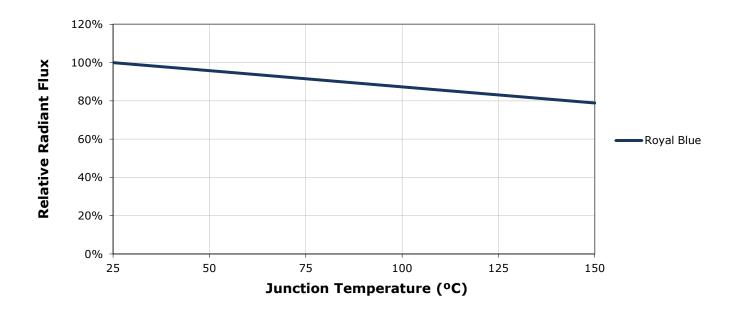






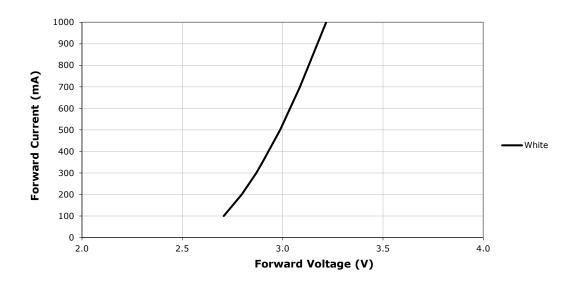
#### RELATIVE FLUX VS. JUNCTION TEMPERATURE ( $I_F = 350 \text{ mA}$ )



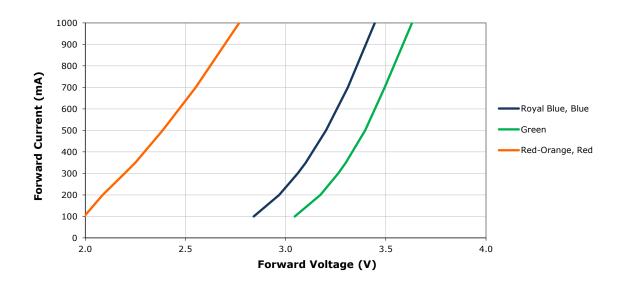




## **ELECTRICAL CHARACTERISTICS (T<sub>j</sub> = 85 °C)**



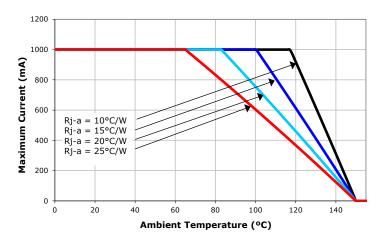
## **ELECTRICAL CHARACTERISTICS (T, = 25 °C)**

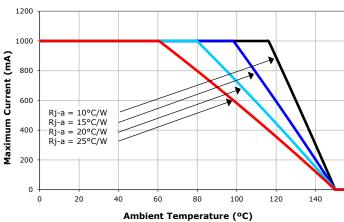




#### THERMAL DESIGN

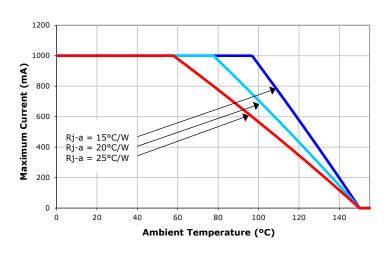
The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.

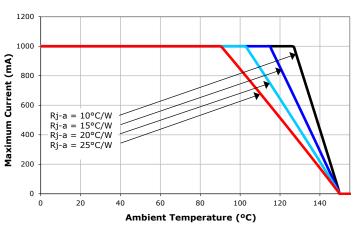




White

Royal Blue, Blue



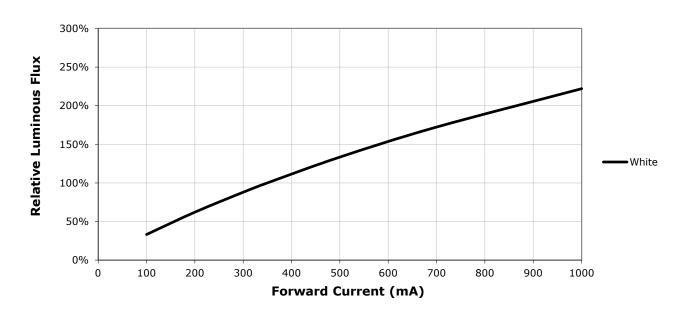


Green

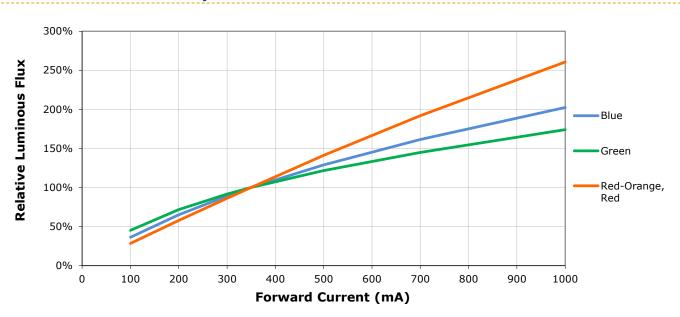
Red-Orange, Red



## RELATIVE FLUX VS. CURRENT ( $T_1 = 85$ °C)

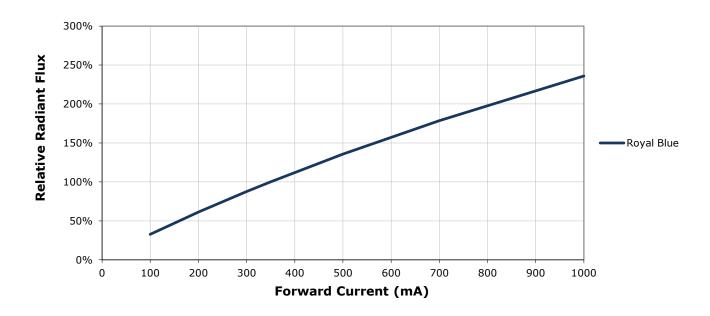


## RELATIVE FLUX VS. CURRENT (T<sub>3</sub> = 25 °C)

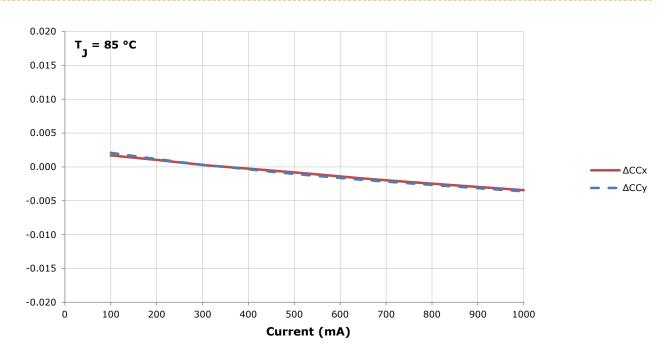




## RELATIVE FLUX VS. CURRENT ( $T_{_{J}}$ = 25 °C) - CONTINUED

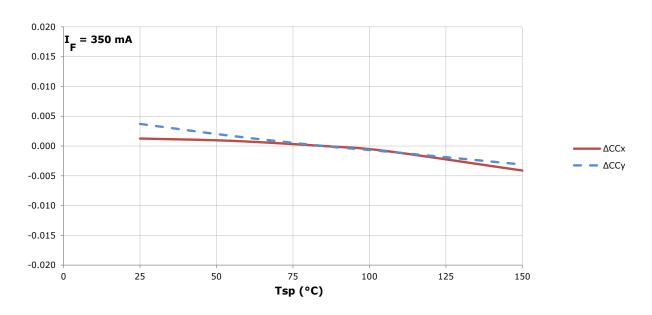


#### **RELATIVE CHROMATICITY VS. CURRENT (WARM WHITE)**

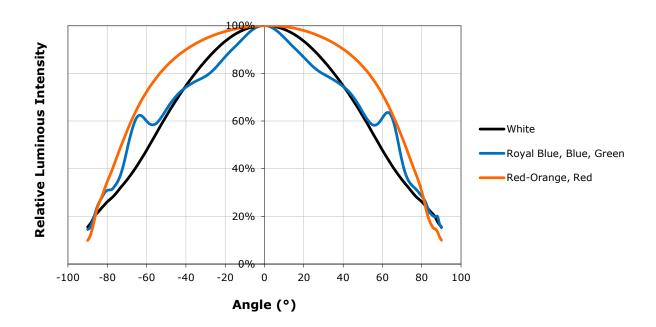




#### **RELATIVE CHROMATICITY VS. TEMPERATURE (WARM WHITE)**



#### TYPICAL SPATIAL DISTRIBUTION

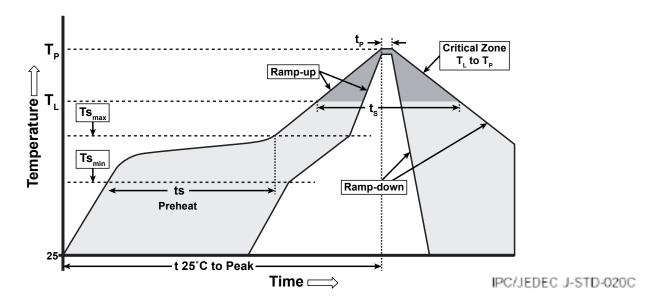




#### **REFLOW SOLDERING CHARACTERISTICS**

In testing, Cree has found XLamp XB-D LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts <sub>max</sub> to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts <sub>min</sub> )	100 °C	150 °C
Preheat: Temperature Max (Ts <sub>max</sub> )	150 °C	200 °C
Preheat: Time (ts <sub>min</sub> to ts <sub>max</sub> )	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T <sub>L</sub> )	183 °C	217 °C
Time Maintained Above: Time (t <sub>L</sub> )	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



#### **NOTES**

#### Lumen Maintenance Projections

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document at www.cree.com/xlamp\_app\_notes/LM80\_results.

Please read the XLamp Long-Term Lumen Maintenance application note at www.cree.com/xlamp\_app\_notes/lumen\_maintenance for more details on Cree's lumen maintenance testing and forecasting. Please read the XLamp Thermal Management application note at www.cree.com/xlamp\_app\_notes/thermal\_management for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

#### Moisture Sensitivity

In testing, Cree has found XLamp XB-D LEDs to have unlimited floor life in conditions ≤30 °C/85% relative humidity (RH). Moisture testing included a 168-hour soak at 85 °C/85% RH followed by 3 reflow cycles, with visual and electrical inspections at each stage.

Cree recommends keeping XLamp LEDs in their sealed moisture-barrier packaging until immediately prior to use. Cree also recommends returning any unused LEDs to the resealable moisture-barrier bag and closing the bag immediately after use.

#### **RoHS** Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as amended through June 8, 2011. RoHS Declarations for this product can be obtain from your Cree representative or obtained from the Product Ecology section of www.cree.com.

#### **REACh Compliance**

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notices of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh Declaration. Historical REACh banned substance information (substances restricted or banned in the EU prior to 2010) is also available upon request.

#### **UL Recognized Component**

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

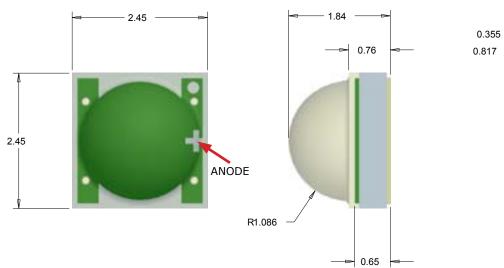
#### Vision Advisory Claim

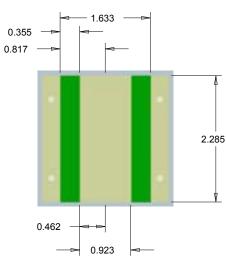
WARNING: Do not look at exposed lamp in operation. Eye injury can result. See the LED Eye Safety application note at www.cree.com/xlamp\_app\_notes/led\_eye\_safety.

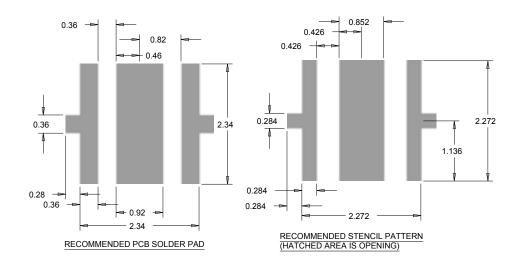


#### **MECHANICAL DIMENSIONS**

All measurements are  $\pm .13$  mm unless otherwise indicated.







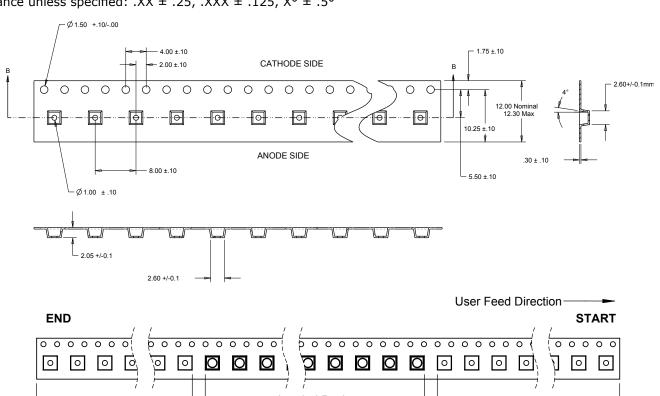


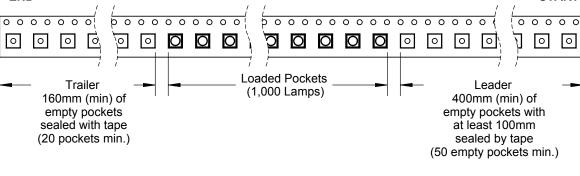
#### **TAPE AND REEL**

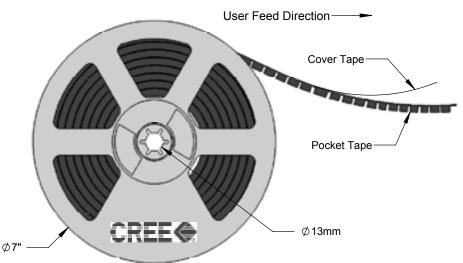
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

#### All dimensions in mm

Tolerance unless specified: .XX  $\pm$  .25, .XXX  $\pm$  .125, X°  $\pm$  .5°









#### **PACKAGING**

# **Unpackaged Reel** Label with Cree Bin Code, Qty, Reel ID

#### **Packaged Reel**

